

### **Metalon<sup>®</sup> Conductive Inks for Printed Electronics**

novacentrix.com

# Metalon<sup>®</sup> CP-008

#### **High Copper Low Temperature Paste**

#### **Product Overview**

**CP-008** is a screen printable copper paste suitable for fine line, high resolution printing. CP-008 is formulated to provide excellent conductivity and adhesion at processing temperatures as low as 140° C. CP-008 can be used on a wide variety of substrates including PET (Melinex ST506), glass, surface treated LCP, Ultem, polyimide and silicon nitride.

#### Applications

**CP-008** paste formulation is designed to allow sintering at temperatures as low as 140° C. The extended sintering latitude makes it compatible with PET and a wide range of substrates from glass to low temperature epoxies and ITO coated substrates. Applications include: LED lighting, microelectronics, and displays & sensors.

#### General Use, Storage and Shelf Life



CP-008 printed on PET & polyimide after a reducing formic acid/argon atmosphere processed  $@150^{\circ}C/1$  hour

The product should be kept sealed in its container and stored at room temperature (<25°C). The shelf life of unopened containers is six months from date of shipment. Prior to use, please ensure that the paste is mixed thoroughly for a few minutes taking care to avoid introducing air to the paste.

#### Safety and Handling

For safety and handling information, please refer to the Material Safety Data Sheet (MSDS).

Typical	Solids Content
Compositional	(Weight %)~ 88%   Viscosity [Pa.S]
Properties	(Anton Paar MCR-301 at 50s <sup>-1</sup> @ 25°C)
Typical	Sheet Resistance
Electrical & Physical	[mΩ/sq/25µm] ~ 10   Adhesion
Properties (Sintered)	(ASTM D3359) 5B   Sintered Thickness [µm] 10 – 15



#### Contact us today to learn more.

For detailed application information or additional assistance: inkstechnicalsupport@novacentrix.com Ink can be ordered at store.novacentrix.com



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Processing	Printing Equipment	Flatbed Screen Printing (both sheet and reel-to-reel) Micro Dispense (nozzle deposition)
	Screen Type	Stainless steel mesh and polyester mesh
	Nozzle Type	High pressure deposition tool (e.g. nScrypt)
	Line Thickness/Height (sintered)	15 μm – 30 μm (depending on deposition process)
	Line Width	50 μm minimum (depending on deposition process)
	Ink on Screen (Printing Life)	> 5 hours
	Substrates	PET, glass, surface treated LCP, FR4 and low temperature epoxies, Ultem, polyimide, silicon nitride and ITO coated substrates
	Clean up solvent	Acetone, isopropanol
	Diluent/Thinner	Terpineol
	Typical Drying Conditions	Can be dried in standard convection ovens and vacuum ovens $\textcircled{0}{0}$ 60°C, 30 – 60 minutes
		IR dryer @ 80°C, 30 minutes
		Forced air convection @ 80°C, 15–30 minutes
	Typical Sintering Conditions	Formic acid reducing atmosphere @ 140°C – 260°C for 1 hour down to 15 minutes
Shipping and Packaging	Standard sample order is 100g or multiples of 100g. Bulk packaging is also available.	





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